

# AKPA6C GPS patch antenna module

## Data Sheet(v1.1)

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# 1. Functional Description

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## 1.1 Overview

The AscenKorea Gms-hpr is an ultra-compact POT (Patch On Top) GPS Module, The module utilizes the MediaTek new generation GPS Chipset MT3339 that achieves the industry's highest level of sensitivity (-165dBm ) and instant Time-to-First Fix (TTFF) with lowest power consumption for precise GPS signal processing to give the ultra-precise positioning under low receptive, high velocity conditions.

Up to 12 multi-tone active interference canceller (ISSCC2011 award), customer can have more flexibility in system design. Supports up to 210 PRN channels with 66 search channels and 22 simultaneous tracking channels, module supports various location and navigation applications, including autonomous GPS, SBAS(note) ranging (WAAS, EGNO, GAGAN, MSAS), AGPS.

Gms-hpr is excellent low power consumption characteristic (acquisition 82mW, tracking 66mW), power sensitive devices, especially portable applications, need not worry about operating time anymore and user can get more fun.

Note: SBAS can only be enabled when update rate is less than or equal to 5Hz.

### Application:

- ✓ Handheld Device
- ✓ Tablet PC/PLB/MID
- ✓ M2M application
- ✓ Asset management
- ✓ Surveillance

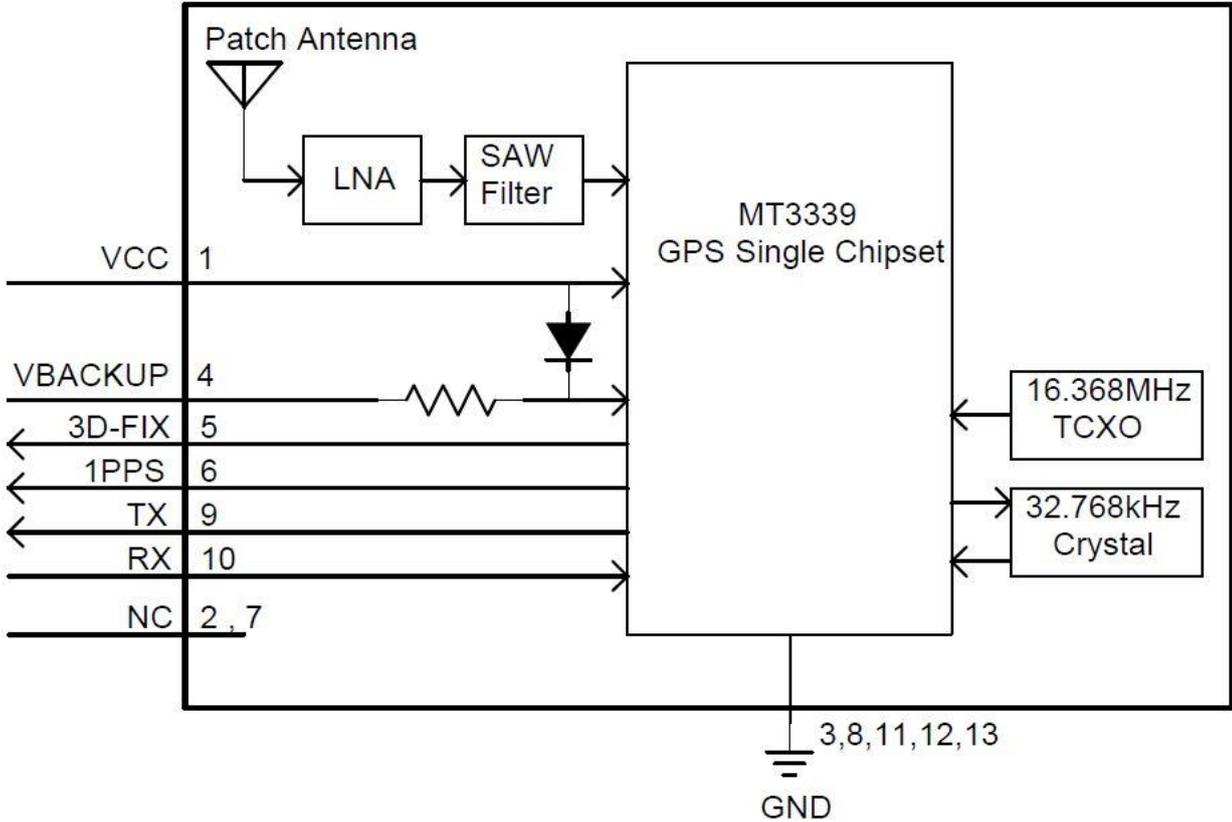
## 1.2 Highlights and Features

- ◆ Built-in 15X15X4mm ceramic patch antenna on the top of module
- ◆ Ultra-High Sensitivity: -165dBm (w/o patch antenna), up to 45dB C/N of SVs in open sky reception.
- ◆ High Update Rate: up to 10Hz<sup>(note1)</sup>
- ◆ 12 multi-tone active interference canceller<sup>(note2)</sup> [ISSCC 2011 Award -Section 26.5]  
([http://isscc.org/doc/2011/isscc2011.advanceprogrambooklet\\_abstracts.pdf](http://isscc.org/doc/2011/isscc2011.advanceprogrambooklet_abstracts.pdf))
- ◆ High accuracy 1-PPS timing support for Timing Applications (10ns jitter)
- ◆ AGPS Support for Fast TTFF (EPO™ Enable 7 days/14 days/30 days )
- ◆ EASY™<sup>(note2)</sup>: Self-Generated Orbit Prediction for instant positioning fix
- ◆ AlwaysLocate™<sup>(note2)</sup> Intelligent Algorithm (Advance Power Periodic Mode) for power saving
- ◆ Logger function Embedded<sup>(note2)</sup>
- ◆ AscenKorea Firmware Customization Services
- ◆ Consumption current(@3.3V):
  - Acquisition: 25mA Typical
  - Tracking: 20mA Typical
- ◆ E911, RoHS, REACH compliant
- ◆ CE, FCC Certification

note 1: SBAS can only be enabled when update rate is less than or equal to 5Hz.

note2: Some features need special firmware or command programmed by customer, please refer to AscenKorea "GPS command List"

1.3 System Block Diagram



## 1.4 Multi-tone active interference canceller

Because different application (Wi-Fi, GSM/GPRS, 3G/4G, Bluetooth) are integrated into navigation system, the harmonic of RF signal will influence the GPS reception, The multi-tone active interference canceller (abbr: MTAIC) can reject external RF interference which come from other active components on the main board, to improve the capacity of GPS reception without any needed HW change in the design. Module can cancel up to 12 independent channels interference continuous wave (CW)

## 1.5 1PPS

A pulse per second (1 PPS) is an electrical signal that very precisely indicates the start of a second. Depending on the source, properly operating PPS signals have an accuracy ranging 10ns.

1 PPS signals are used for precise timekeeping and time measurement. One increasingly common use is in computer timekeeping, including the NTP protocol. A common use for the PPS signal is to connect it to a PC using a low-latency, low-jitter wire connection and allow a program to synchronize to it:

Module supply the high accurate 1PPS timing to synchronize to GPS time after 3D-Fix.  
A power-on output 1pps is also available for customization firmware settings.

### 1.6 EASY™

The EASY™ is embedded assist system for quick positioning, the GPS engine will calculate and predict automatically the single emperies ( Max. up to 3 days )when power on ,and save the predict information into the memory , GPS engine will use these information for positioning if no enough information from satellites, so the function will be helpful for positioning and TTFF improvement under indoor or urban condition.

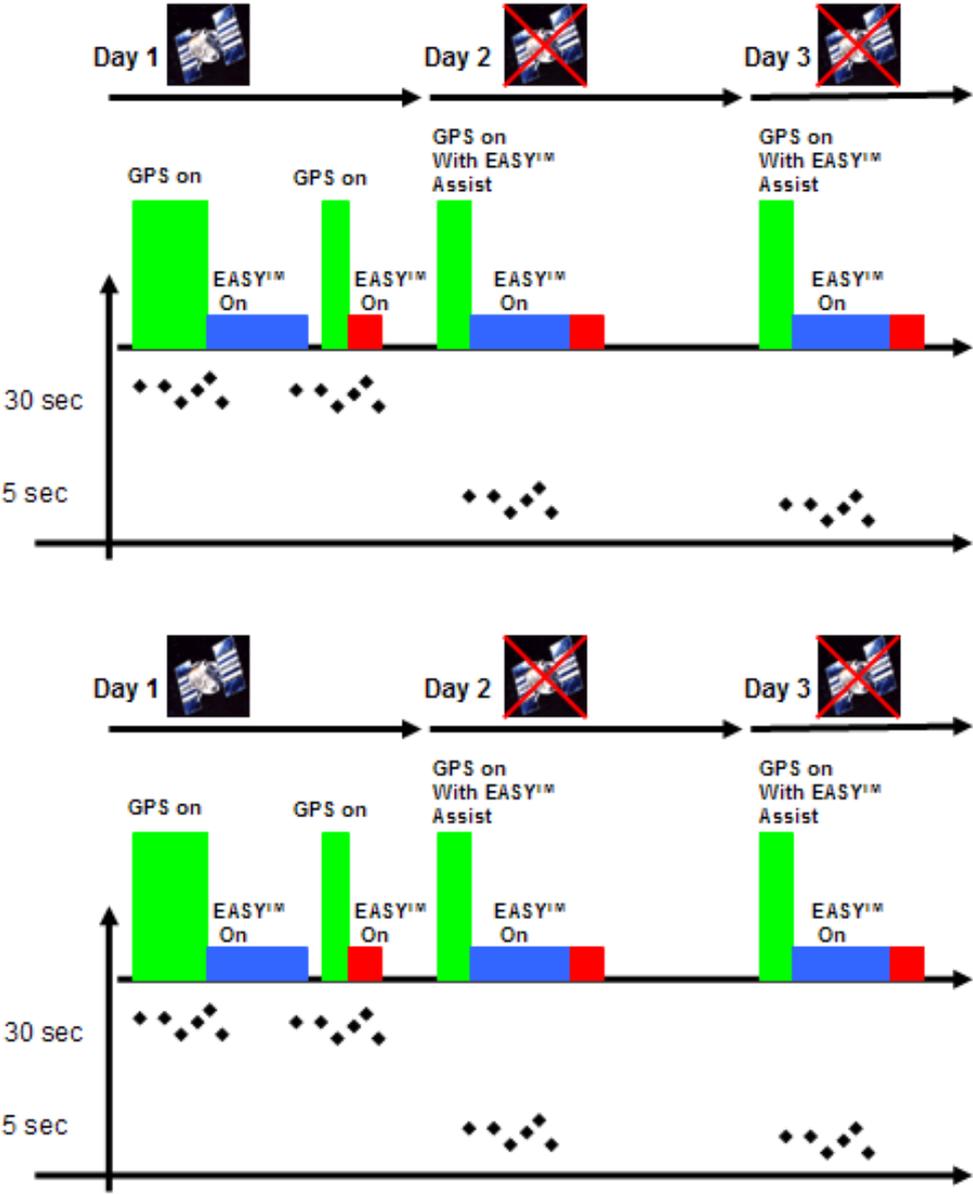


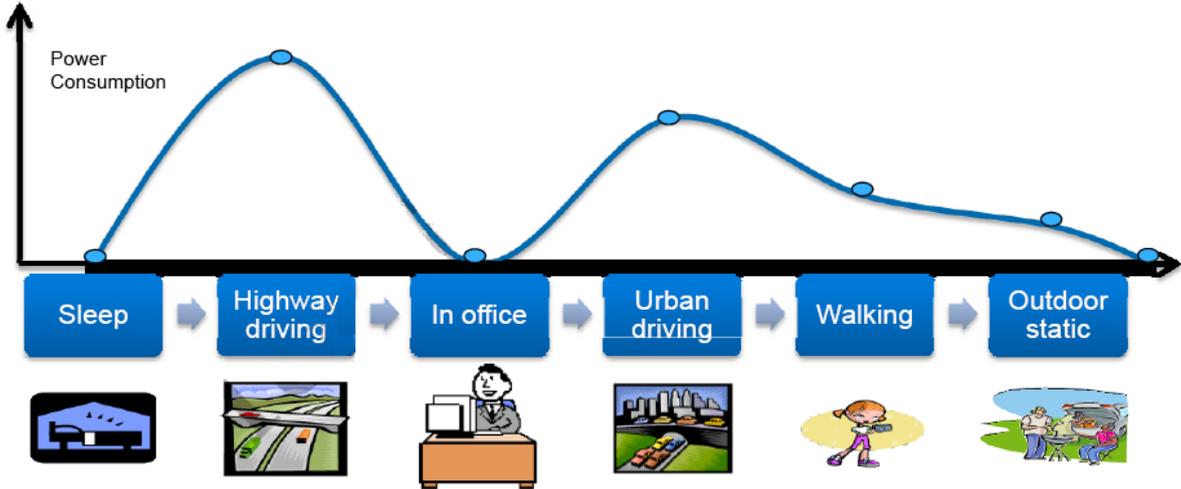
Figure 1.12-1 EASY System operation

Please refer to the Fig 1.12-1, When GPS device great the satellite information from GPS satellites, the GPS engine automatically pre-calculate the predict orbit information for 3 days

The GPS device still can quickly do the positioning with EASY™ function under weak GPS signal.

### 1.7 AlwaysLocate™ (Advance Power Periodic Mode)

Embedded need to be executed full y all the time , the algorithm can be set by different necessary to decide the operation level of GPS function , reduce power consumption , it will suffer positing accuracy to get the target of power saving and extend the usage time of product . (The positioning accuracy of reporting location < 50m (CEP)



### 1.8 Embedded Logger function

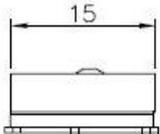
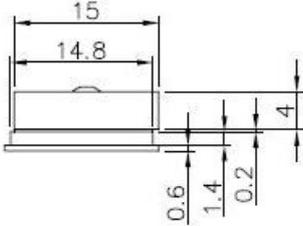
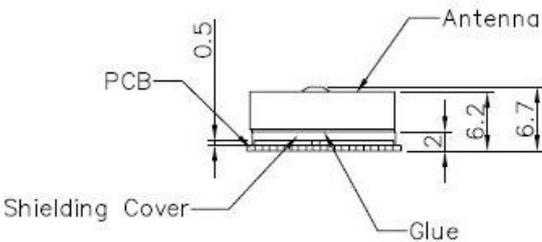
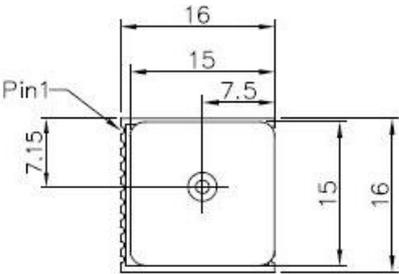
The Embedded Logger function don't need host CPU (MCU ) and external flash to handle the operation , GPS Engine will use internal flash (embedded in GPS chipset ) to log the GPS data (Data format : UTC, Latitude , longitude, Valid ,Checksum ), the max log days can up to 2 days under AlwaysLocate™ condition .<sup>Note</sup>

Note: Data size per log was shrunk from 24 bytes to 15 bytes.

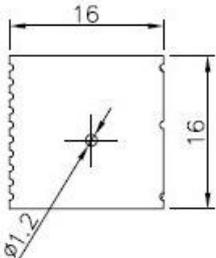
## 2. Specification

### 2.1 Mechanical Dimension

Dimension: (Unit: mm, Tolerance: +/- 0.2mm)

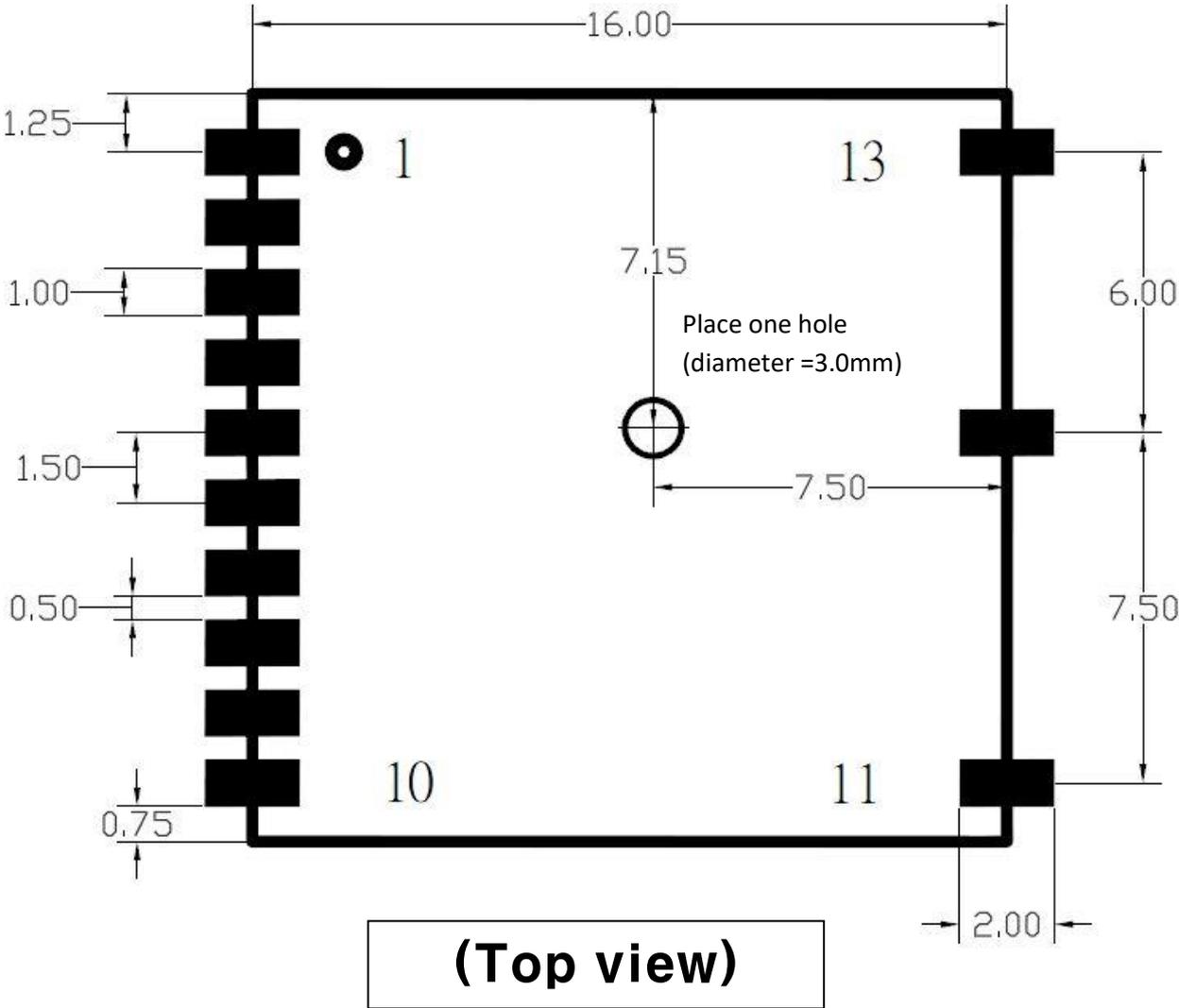


Unit : mm  
Assemble Tolerance : 0.2mm

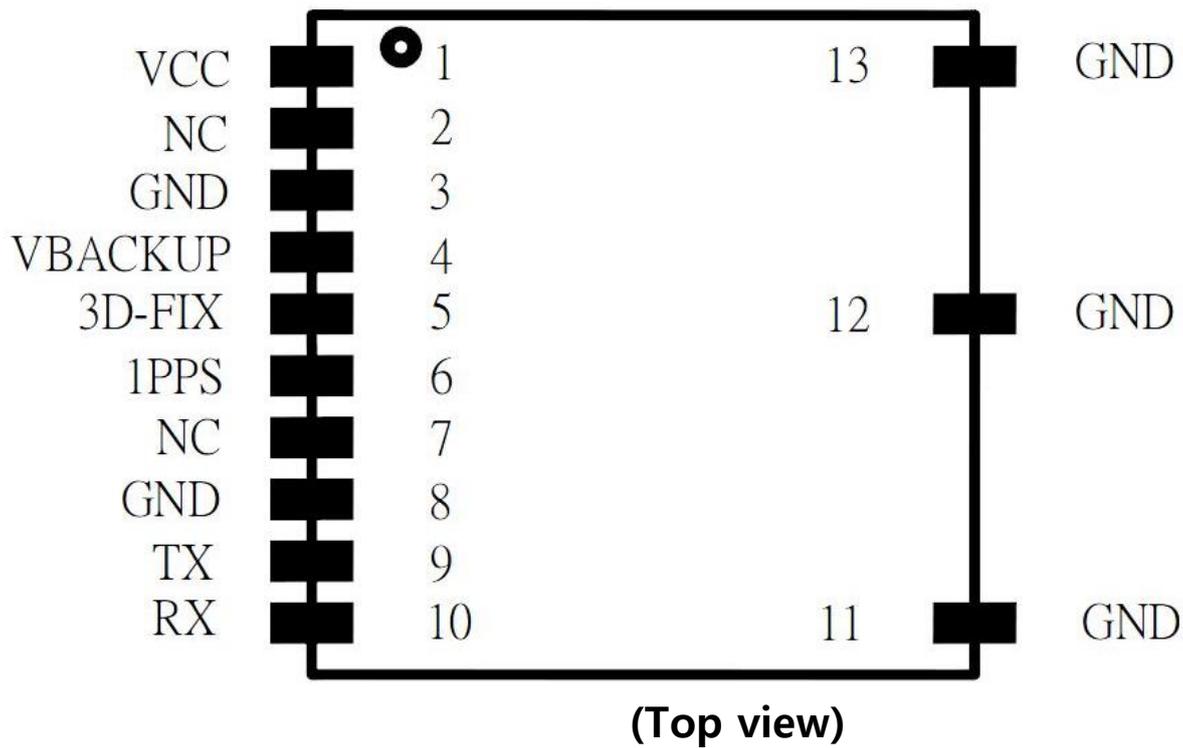


### 2.2 PCB pad Layout

(단위: mm, 공차: 0.1mm)



## 2.3 Pin Configuration



## 2.4 Pin Assignment

Pin	Name	I/O	Description & Note
1	<b>VCC</b>	PI	Main DC power input
2	<b>NC</b>	—	None
3	<b>GND</b>	P	Ground
4	<b>VBACKUP</b>	PI	Backup power input for RTC & navigation data keep
5	<b>3D-FIX</b>	O	3D-Fix Indicator
6	<b>1PPS</b>	O	1PPS Time Mark Output 2.8V CMOS Level
7	<b>NC</b>	—	None
8	<b>GND</b>	P	Ground
9	<b>TX</b>	O	Serial Data Output A for NMEA output (TTL)
10	<b>RX</b>	I	Serial Data Input A for Firmware update (TTL)
11	<b>GND</b>	P	Ground
12	<b>GND</b>	P	Ground
13	<b>GND</b>	P	Ground

## 2.5 Description of I/O Pin

### VCC (Pin1)

The main DC power supply of the module, the voltage should be kept between from 3.0V to 5V. **The Vcc ripple must be controlled under 50mV<sub>pp</sub> (Typical: 3.3V)**

### ENABLE (Pin2)

Keep open or pull high to Power ON. Pull low to shutdown the module.

**Enable (High):**  $1.8V \leq V_{enable} \leq VCC$

**Disable (Low):**  $0V \leq V_{enable} \leq 0.25V$

### GND (Pin3 and Pin8)

Ground

### VBACKUP (Pin4)

This connects to the backup power of the GPS module. Power source (such as battery) connected to this pin will help the GPS chipset in keeping its internal RTC running when the main power source is turned off. The voltage should be kept between **2.0V~4.3V, Typical 3.0V.**

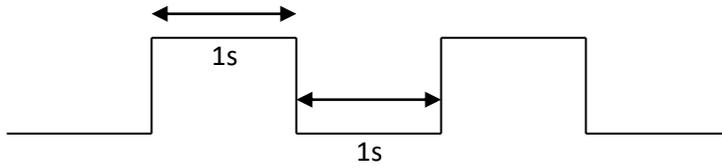
**IF VBACKUP power was not reserved, the GPS module will perform a lengthy cold start every time it is powered-on because previous satellite information is not retained and needs to be re-transmitted.**

If not used, keep open.

### 3D-FIX (Pin5)

The 3D-FIX is assigned as a fix flag output. The timing behavior of this pin can be configured by custom firmware for different applications (Example: waking up host MCU). If not used, keep floating.

- Before 2D Fix  
The pin should continuously output one-second high-level with one-second low-level signal.



- After 2D or 3D Fix  
The pin should continuously output low-level signal.

Low 

## 1PPS (Pin6)

This pin provides one pulse-per-second output from the module and synchronizes to GPS time.

Keep floating if not used.

## NC (Pin7)

These are NC pins, they are not connected.

## TX (Pin9)

This is the UART transmitter of the module. It outputs the GPS information for application.

## RX (Pin10)

This is the UART receiver of the module. It is used to receive software commands and firmware update.

## 2.6 Specification List

	Description
<b>GPS Solution</b>	MTK MT3339
<b>Frequency</b>	L1, 1575.42MHz
<b>Sensitivity<sup>1</sup></b>	Acquisition: -148dBm, cold start Reacquisition: -163dBm, Hot start Tracking: -165dBm
<b>Channel</b>	66 channels
<b>TTF</b>	Hot start: 1 second typical Warm start: 33 seconds typical Cold start: 35 seconds typical (No. of SVs>4, C/N>40dB, PDop<1.5)
<b>Position Accuracy</b>	Without aid:3.0m (50% CEP) DGPS(SBAS(WAAS,EGNOS,MSAS)):2.5m (50% CEP)
<b>Velocity Accuracy</b>	Without aid : 0.1m/s DGPS(SBAS(WAAS,EGNOS,MSAS,GAGAN)):0.05m/s Without aid:0.1 m/s <sup>2</sup>
<b>Acceleration Accuracy</b>	Without aid:0.1 m/s <sup>2</sup> DGPS(SBAS(WAAS,EGNOS,MSAS)):0.05m/s <sup>2</sup>
<b>Timing Accuracy (1PPS Output)</b>	10 ns RMS
<b>Altitude</b>	Maximum 18,000m (60,000 feet)
<b>Velocity</b>	Maximum 515m/s (1000 knots)
<b>Acceleration</b>	Maximum 4G
<b>Update Rate</b>	1Hz (default), maximum 10Hz
<b>Baud Rate</b>	9600 bps (default)
<b>DGPS</b>	SBAS(default) [QZSS,WAAS, EGNOS, MSAS,GAGAN]
<b>AGPS</b>	Support
<b>Power Supply</b>	VCC : 3.0V to 4.3V ; VBACKUP : 2.0V to 4.3V
<b>Current Consumption</b>	25mA acquisition, 20mA tracking
<b>Working Temperature</b>	-40 °C to +85 °C
<b>Dimension</b>	16 x 16x 6.2mm, SMD
<b>Weight</b>	6g

## 2.7 Absolute Maximum Ratings

The voltage applied for VCC should not exceed as below:

	Symbol	Min.	Typ.	Max.	Unit
<b>Power Supply Voltage</b>	VCC	3.0	3.3	4.3	V
<b>Backup battery Voltage</b>	VBACKUP	2.0	3.0	4.3	V

## 2.8 Operating Conditions

	Condition	Min.	Typ.	Max.	Unit
<b>Operation supply Ripple Voltage</b>	—	—	—	50	mVpp
<b>RX0 TTL H Level</b>	VCC=3.0~4.3V	2.0	—	VCC	V
<b>RX0 TTL L Level</b>	VCC=3.0~4.3V	0	—	0.8	V
<b>TX0 TTL H Level</b>	VCC=3.0~4.3V	2.4	—	2.8	V
<b>TX0 TTL L Level</b>	VCC=3.0~4.3V	0	—	0.4	V
<b>Current Consumption @ 3.3V, 1Hz Update Rate</b>	Acquisition	—	25	—	mA
	Tracking	—	20	—	mA
<b>Backup Power Consumption@ 3V</b>	25°C	—	7	—	uA

## 3. Protocols

### 3.1 NMEA Output Sentences

**Table-1** lists each of the NMEA output sentences specifically developed and defined by MTK for use within MTK products

<b>Table-1: NMEA Output Sentence</b>	
<b>Option</b>	<b>Description</b>
GGA	Time, position and fix type data.
GSA	GPS receiver operating mode, active satellites used in the position solution and DOP values.
GSV	The number of GPS satellites in view satellite ID numbers, elevation, azimuth, and SNR values.
RMC	Time, date, position, course and speed data. Recommended Minimum Navigation Information.
VTG	Course and speed information relative to the ground.

**GGA—Global Positioning System Fixed Data. Time, Position and fix related data**

**Table-2** contains the values for the following example :

\$GPGGA,064951.000,2307.1256,N,12016.4438,E,1,8,0.95,39.9,M,17.8,M,,\*65

**Table-2: GGA Data Format**

Name	Example	Units	Description
Message ID	\$GPGGA		GGA protocol header
UTC Time	064951.000		hhmmss.sss
Latitude	2307.1256		ddmm.mmmm
N/S Indicator	N		N=north or S=south
Longitude	12016.4438		dddmm.mmmm
E/W Indicator	E		E=east or W=west
Position Fix Indicator	1		See <b>Table-3</b>
Satellites Used	8		Range 0 to 14
HDOP	0.95		Horizontal Dilution of Precision
MSL Altitude	39.9	meters	Antenna Altitude above/below mean-sea-level
Units	M	meters	Units of antenna altitude
Geoidal Separation	17.8	meters	
Units	M	meters	Units of geoids separation
Age of Diff. Corr.		second	Null fields when DGPS is not used
Checksum	*65		
<CR> <LF>			End of message termination

**Table-3: Position Fix Indicator**

Value	Description
0	Fix not available
1	GPS fix
2	Differential GPS fix

## GSA—GNSS DOP and Active Satellites

**Table-4** contains the values for the following example :

\$GPGSA,A,3,29,21,26,15,18,09,06,10,,,,,2.32,0.95,2.11\*00

Table-4: GSA Data Format			
Name	Example	Units	Description
Message ID	\$GPGSA		GSA protocol header
Mode 1	A		See <b>Table-5</b>
Mode 2	3		See <b>Table-6</b>
Satellite Used	29		SV on Channel 1
Satellite Used	21		SV on Channel 2
....	....	....	....
Satellite Used			SV on Channel 12
PDOP	2.32		Position Dilution of Precision
HDOP	0.95		Horizontal Dilution of Precision
VDOP	2.11		Vertical Dilution of Precision
Checksum	*00		
<CR> <LF>			End of message termination

Table-5: Mode 1	
Value	Description
M	Manual—forced to operate in 2D or 3D mode
A	2D Automatic—allowed to automatically switch 2D/3D

Table-6: Mode 2	
Value	Description
1	Fix not available
2	2D (< 4 SVs used)
3	3D ( $\geq 4$ SVs used)

**GSV—GNSS Satellites in View**

**Table-7** contains the values for the following example :

\$GPGSV,3,1,09,29,36,029,42,21,46,314,43,26,44,020,43,15,21,321,39\*7D

\$GPGSV,3,2,09,18,26,314,40,09,57,170,44,06,20,229,37,10,26,084,37\*77

\$GPGSV,3,3,09,07,,,26\*73

Table-7: GSV Data Format			
Name	Example	Units	Description
Message ID	\$GPGSV		GSV protocol header
Number of Messages	3		Range 1 to 3 <i>(Depending on the number of satellites tracked, multiple messages of GSV data may be required.)</i>
Message Number1	1		Range 1 to 3
Satellites in View	09		
Satellite ID	29		Channel 1 (Range 1 to 32)
Elevation	36	degrees	Channel 1 (Maximum 90)
Azimuth	029	degrees	Channel 1 (True, Range 0 to 359)
SNR (C/No)	42	dBHz	Range 0 to 99, (null when not tracking)
....	....	....	....
Satellite ID	15		Channel 4 (Range 1 to 32)
Elevation	21	degrees	Channel 4 (Maximum 90)
Azimuth	321	degrees	Channel 4 (True, Range 0 to 359)
SNR (C/No)	39	dBHz	Range 0 to 99, (null when not tracking)
Checksum	*7D		
<CR> <LF>			End of message termination

**RMC—Recommended Minimum Navigation Information**

**Table-8** contains the values for the following example :

\$GPRMC,064951.000,A,2307.1256,N,12016.4438,E,0.03,165.48,260406,3.05,W,A\*2C

Table-8: RMC Data Format			
Name	Example	Units	Description
Message ID	\$GPRMC		RMC protocol header
UTC Time	064951.000		hhmmss.sss
Status	A		A=data valid or V=data not valid
Latitude	2307.1256		ddmm.mmmm
N/S Indicator	N		N=north or S=south
Longitude	12016.4438		dddmm.mmmm
E/W Indicator	E		E=east or W=west
Speed over Ground	0.03	knots	
Course over Ground	165.48	degrees	True
Date	260406		ddmmyy
Magnetic Variation	3.05, W	degrees	E=east or W=west (Need Ascenkorea Customization Service)
Mode	A		A= Autonomous mode D= Differential mode E= Estimated mode
Checksum	*2C		
<CR> <LF>			End of message termination

**VTG—Course and speed information relative to the ground**

**Table-9** contains the values for the following example:

\$GPVTG,165.48,T,,M,0.03,N,0.06,K,A\*37

Table-9: VTG Data Format			
Name	Example	Units	Description
Message ID	\$GPVTG		VTG protocol header
Course	165.48	degrees	Measured heading
Reference	T		True
Course		degrees	Measured heading
Reference	M		<b>Magnetic</b> <b>(Need Ascenkorea Customization Service)</b>
Speed	0.03	knots	Measured horizontal speed
Units	N		Knots
Speed	0.06	km/hr	Measured horizontal speed
Units	K		Kilometers per hour
Mode	A		A= Autonomous mode D= Differential mode E= Estimated mode
Checksum	*06		
<CR> <LF>			End of message termination

## 3.2 MTK NMEA Command Protocols

**Packet Type:**

103 PMTK\_CMD\_COLD\_START

**Packet Meaning:**

Cold Start : Don't use Time, Position, Almanacs and Ephemeris data at re-start.

**Example:**

\$PMTK103\*30<CR><LF>

## 3.3 Firmware Customization Services

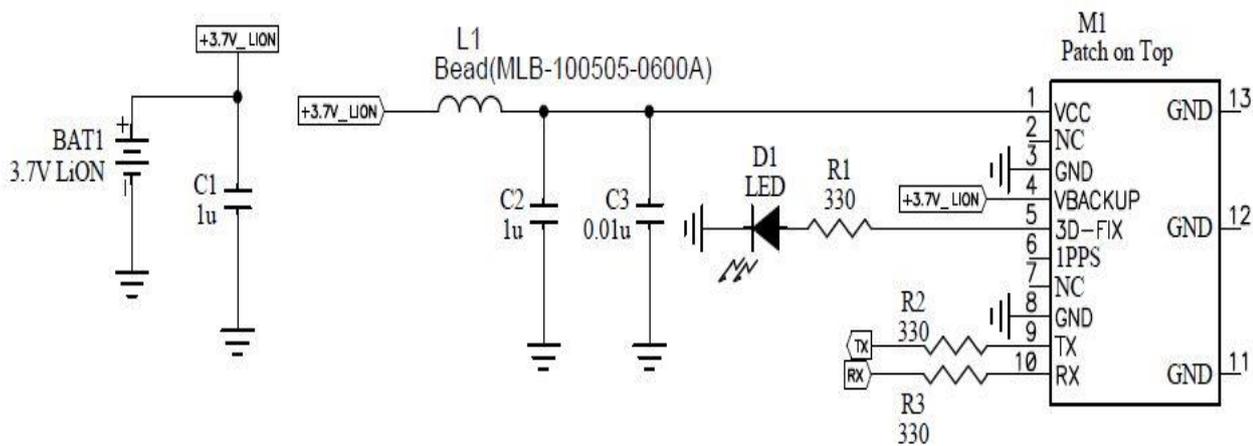
AscenKorea also offers flexible, value-adding GPS firmware customization services that maximizes the over system efficiencies and power consumptions. Latest functions like Binary Mode, 1-Sentence Output, Geo-fencing and Last Position Retention, please see our website at [www.AscenKorea.com](http://www.AscenKorea.com) under Products / GPS Modules / Software Services for more details.

**Note:** Not all firmware customization services listed below are supported by Module. Please contact AscenKorea Sales or Technical Support for more details.

## 4. Reference Design

This chapter introduces the reference schematic design for the best performance. Additional tips and cautions on design are well documented on Application Note, which is available upon request.

### 4.1 Reference Design Circuit



#### Note:

1. Ferrite bead L1 is added for power noise reduction.
2. C2 and C3 bypass should be put near the module.  
For C1, the value chosen depends on the amount of system noise, the range from 1μF to 100μF is reasonable.
3. Damping resistors R2 and R3 could be modified based on system application for EMI.
4. If you need more support and information on antenna implementation, please directly contact us at [sales@ascen.co.kr](mailto:sales@ascen.co.kr) for further services.

## 5. Reflow Soldering Temperature Profile

The following reflow temperature profile was evaluated by Ascenkorea and has been proven to be reliable qualitatively. Please contact us beforehand if you plan to solder this component using a deviated temperature profile as it may cause significant damage to our module and your device.

All the information in this sheet can only be used only for Pb-free manufacturing process.

### 5.1 SMT Reflow Soldering Temperature Profile (Reference Only)

Average ramp-up rate (25 ~ 150°C): 3°C/sec. max.

Average ramp-up rate (270°C to peak): 3°C/sec. max.

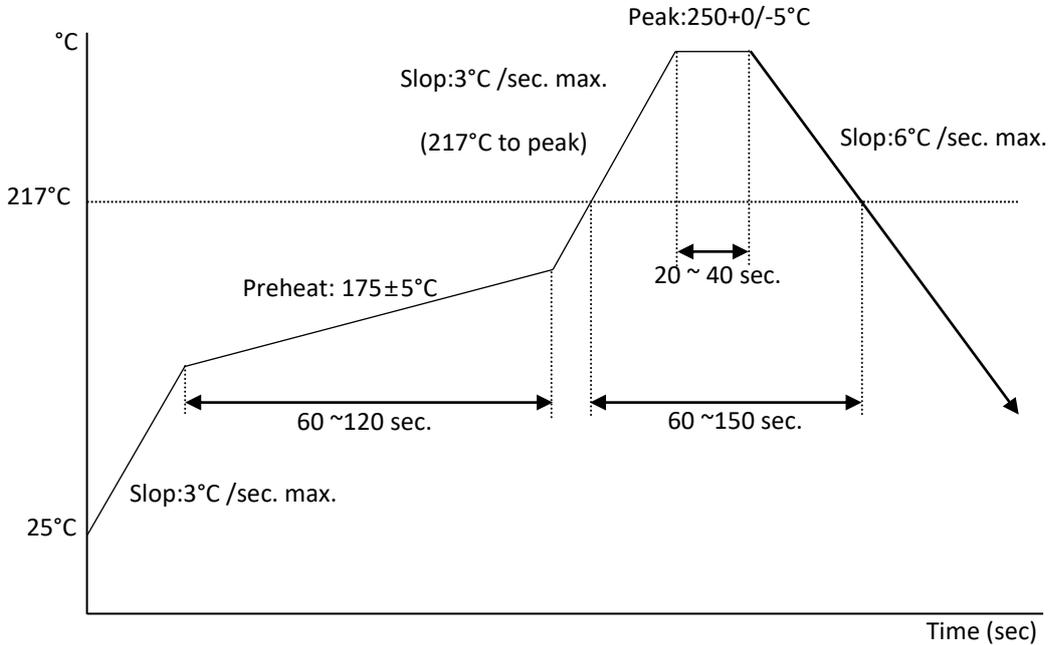
Preheat: 175 ± 25°C, 60 ~ 120 seconds

Temperature maintained above 217°C: 60~150 seconds

Peak temperature: 250 +0/-5°C, 20~40 seconds

Ramp-down rate: 6°C/sec. max.

Time 25°C to peak temperature: 8 minutes max.



	Details	Suggestions	Notes
1	Before proceeding with the reflow-soldering process, the GPS module must be pre-baked.	Pre-bake Time: 6 Hours @ 60°±5°C or 4 Hours @ 70°±5°C	<b>The maximum tolerated temperature for the tray is 100°C.</b>  <b>After the pre-baking process, please make sure the temperature is sufficiently cooled down to 35°C or below in order to prevent any tray deformation.</b>
2	Because PCBA (along with the patch antenna) is highly endothermic during the reflow-soldering process, extra care must be paid to the GPS module's solder joint to see if there are any signs of cold weld(ing) or false welding.	The parameters of the reflow temperature must be set accordingly to module's reflow-soldering temperature profile.	<b>Double check to see if the surrounding components around the GPS module are displaying symptoms of cold weld(ing) or false welding.</b>
3	Special attentions are needed for PCBA board during reflow-soldering to see if there are any symptoms of bending or deformation to the PCBA board, possibility due to the weight of the module. If so, this will cause concerns at the latter half of the production process.	A loading carrier fixture must be used with PCBA if the reflow soldering process is using rail conveyors for the production.	<b>If there is any bending or deformation to the PCBA board, this might causes the PCBA to collide into one another during the unloading process.</b>
4	Before the PCBA is going through the reflow-soldering process, the production operators must check by eyesight to see if there are positional offset to the module, because it will be difficult to readjust after the module has gone through reflow-soldering process.	The operators must check by eyesight and readjust the position before reflow-soldering process.	<b>If the operator is planning to readjust the module position, please do not touch the patch antenna while the module is hot in order to prevent rotational offset between the patch antenna and module</b>

**Note:** References to patch antenna is referred to GPS modules with integrated Patch-on-top antennas (PA/Gms Module Series), and may not be applicable to all GPS modules.

	Details	Suggestions	Notes
5	Before handling the PCBA, they must be cooled to 35°C or below after they have gone through the reflow-soldering process, in order to prevent positional shift that might occur when the module is still hot.	<p>1. Can use electric fans behind the Reflow machine to cool them down.</p> <p>2. Cooling the PCBA can prevent the module from shifting due to fluid effect.</p>	<b>It is very easy to cause positional offset to the module and its patch antenna when handling the PCBA under high temperature.</b>
6	<p>1. When separating the PCBA panel into individual pieces using the V-Cut process, special attentions are needed to ensure there are sufficient gap between patch antennas so the patch antennas are not in contact with one another.</p> <p>2. If V-Cut process is not available and the pieces must be separated manually, please make sure the operators are not using excess force which may cause rotational offset to the patch antennas.</p>	<p>1. The blade and the patch antenna must have a distance gap greater than 0.6mm.</p> <p>2. Do not use patch antenna as the leverage point when separating the panels by hand.</p>	<p><b>1. Test must be performed first to determine if V-Cut process is going to be used. There must be enough space to ensure the blade and patch antenna do not touch one another.</b></p> <p><b>2. An uneven amount of manual force applied to the separation will likely to cause positional shift in patch antenna and module.</b></p>
7	When separating panel into individual pieces during latter half of the production process, special attentions are needed to ensure the patch antennas do not come in contact with one another in order to prevent chipped corners or positional shifts.	Use tray to separate individual pieces.	<b>It is possible to chip corner and/or cause a shift in position if patch antennas come in contact with each other.</b>

**Note:** References to patch antenna is referred to GPS modules with integrated Patch-on-top antennas (PA/Gms Module Series), and may not be applicable to all GPS modules.

**Other Cautionary Notes on Reflow-Soldering Process:**

1. Module must be pre-baked **before** going through SMT solder reflow process.
2. The usage of solder paste should follow “first in first out” principle. Opened solder paste needs to be monitored and recorded in a timely fashion (can refer to IPQC for related documentation and examples).
3. Temperature and humidity must be controlled in SMT production line and storage area. Temperature of 23°C, 60±5% RH humidity is recommended. (please refer to IPQC for related documentation and examples)
4. When performing solder paste printing, please notice if the amount of solder paste is in excess or insufficient, as both conditions may lead to defects such as electrical shortage, empty solder and etc.
5. Make sure the vacuum mouthpiece is able to bear the weight of the GPS module to prevent positional shift during the loading process.
6. Before the PCBA is going through the reflow-soldering process, the operators should check by eyesight to see if there are positional offset to the module.
7. The reflow temperature and its profile data must be measured before the SMT process and match the levels and guidelines set by IPQC.
8. If SMT protection line is running a double-sided process for PCBA, please process GPS module during the second pass only to avoid repeated reflow exposures of the GPS module. Please contact Ascenkorea beforehand if you must process GPS module during the 1<sup>st</sup> pass of double-side process.

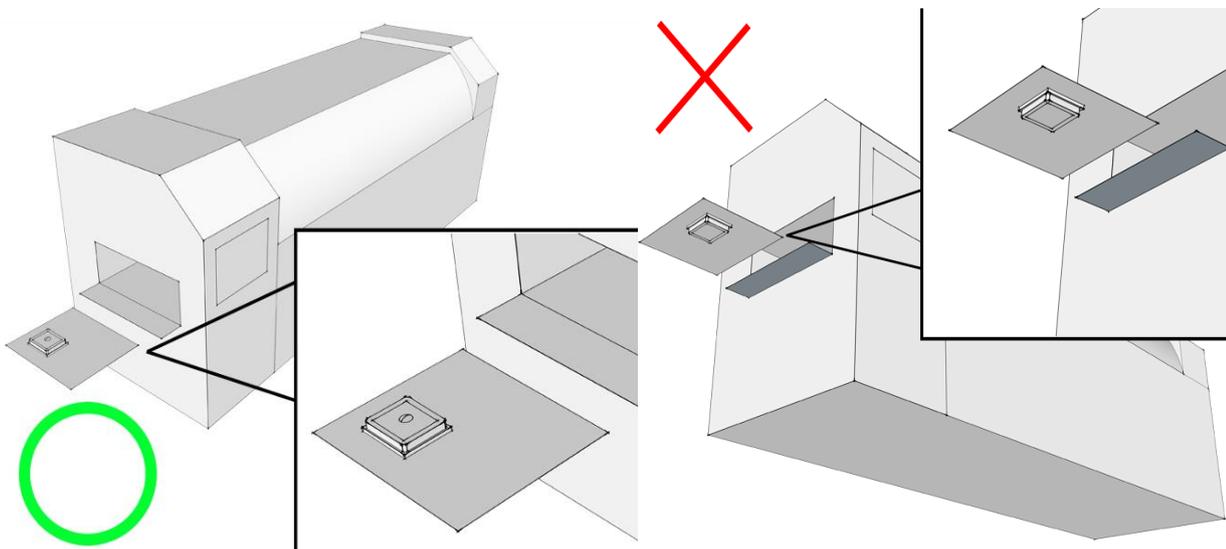


Figure 6.2: Place GPS module right-side up when running reflow-solder process, do not invert.

9. Module must be pre-baked **before** going through SMT solder reflow process.
10. The usage of solder paste should follow “first in first out” principle. Opened solder paste needs to be monitored and recorded in a timely fashion (can refer to IPQC for related documentation and examples).
11. Temperature and humidity must be controlled in SMT production line and storage area. Temperature of 23°C, 60±5% RH humidity is recommended. (please refer to IPQC for related documentation and examples)
12. When performing solder paste printing, please notice if the amount of solder paste is in excess or insufficient, as both conditions may lead to defects such as electrical shortage, empty solder and etc.
13. The reflow temperature and its profile data must be measured before the SMT process and match the levels and guidelines set by IPQC.

## 5.2 Manual Soldering

### Soldering iron:

Bit Temperature: Under 380°C      Time: Under 3 sec.

### Notes:

1. Please do not directly touch the soldering pads on the surface of the PCB board, in order to prevent further oxidation
2. The solder paste must be defrosted to room temperature before use so it can return to its optimal working temperature. The time required for this procedure is unique and dependent on the properties of the solder paste used.
3. The steel plate must be properly assessed before and after use, so its measurement stays strictly within the specification set by SOP.
4. Please watch out for the spacing between soldering joint, as excess solder may cause electrical shortage
5. Please exercise with caution and do not use extensive amount of flux due to possible siphon effects on neighboring components, which may lead to electrical shortage.
6. Please do not use the heat gun for long periods of time when removing the shielding or inner components of the GPS module, as it is very likely to cause a shift to the inner components and will leads to electrical shortage.